



UNITED STATES DEPARTMENT OF COMMERCE - Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

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ATTORNEY DOCKET NO TITLE

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FIRST NAMED APPLICANT

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NOTICE TO FILE MISSING PARTS OF APPLICATION FILED UNDER 37 CFR 1.60 FILING DATE GRANTED

A filing date has been granted to this application filed under 37 CFR 1.60. However, the items for large entities or \$ ____ for small entities who have complied with 37 CFR 1.28(a). The surcharge is set forth in 37 CFR 1.16 (e).

If all required items on this form are filed within the period set below, the total amount owed by applicant as a large entity, a small entity (verified statement filed), is \$_12

Applicant is given ONE MONTH FROM THE DATE OF THIS LETTER, OR TWO MONTHS FROM THE FILING DATE of this application, WHICHEVER IS LATER, within which to file all required items and pay any fees required above to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136 (a).

1. 🗆	The statutory basic filing fee is: ☐ missing ☐ insufficient. Applicant as a ☐ large entity, ☐ small entity, must submit \$ to complete the basic filing fee.
2. □	Additional claim fees of \$ as a \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
3.	The application was filed under 37 CFR 1.60. The copy of the oath or declaration wissing does not show applicant(s) signature or an indication it was signed. A copy of the signed oath or declaration originally filed in the prior complete application is required.
4. 🗆	OTHER:
Direct Divisi	the response and any questions about this notice to, Attention: Application Processing on, Special Processing and Correspondence Branch.
	A copy of this notice <u>MUST</u> be returned with the response.
	CATION PROCESSING DIVISION 08-1202

COPY TO BE RETURNED WITH RESPONSE

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HP Docket No.: 1092623-0

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed

Jesome Dechant

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Fred A. Kish et al.

Group Art Unit:

Serial No.: 08/298,691

Examiner:

Filed: 08/31/94

Title: Wafer Bonding Of Light Emitting Diode Layers

TRANSMITTAL LETTER FOR SUBMITTAL OF MISSING PARTS

Commissioner of Patents and Trademarks Washington, D.C. 20231

Sir:

This is in response to a Notice to File Missing Parts of Application under 37 CFR 1.53 (d) mailed on October 13, 1994. Enclosed is a copy of said Notice and the following documents and fee to complete the filing requirements of the above-identified application.

- (X) Copy of the Original Executed Declaration and Power of Attorney as filed with the Original Patent Application filed March 19, 1993 and assigned Ser. No. 08/036,532 of which this is a Divisional Patent Application.
- (X) Missing Parts Surcharge of \$130.00

Please charge to Deposit Account 08-2025 the sum of \$130.00. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 08-2025 pursuant to 37 CFR 1.25.

(X) A duplicate copy of this transmittal letter is enclosed.

Respectfully submitted, Fred A. Kish et al.

Hewlett-Packard Company Legal Department, M/S 20BO P.O. Box 10301 Palo Alto, CA 94303-0890

Date: <u>/0-24-94</u> Ph.No. (408) 447-6153